



Power MOSFETS

DATASHEET

LM45180NAI8A

N-Channel
Enhancement Mode MOSFET

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Quality Management Systems
ISO 9001:2015 Certificate

LM45180NAI8A

N-Channel Enhancement Mode MOSFET

Pin Description

Product Summary

PDFN3.3*3.3		Symbol	Symbol	N-Channel	Unit
Top View	Bottom View				
			V _{DSS}	45	V
			R _{DS(ON)-Max}	18	mΩ
			I _D	30	A

Feature

- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS Tested

Applications

- Power Management in Notebook Computer
- Portable Equipment and Battery Powered systems

Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM45180NAI8A	PDFN3.3*3.3	Tape & Reel	5000 / Tape & Reel	45180 <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/>

Note : = Lot Code

Absolute Maximum Ratings ($T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit
V _{DSS}	Drain-Source Voltage	45	V
V _{GSS}	Gate-Source Voltage	±20	
T _J	Maximum Junction Temperature	150	°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
I _S	Diode Continuous Forward Current	T _c =25°C 27	A
I _{DM} ⁽¹⁾	Pulse Drain Current Tested	T _c =25°C 71	A
I _D	Continuous Drain Current	T _c =25°C 30	A
		T _c =100°C 19	
P _D	Maximum Power Dissipation	T _c =25°C 30	W
		T _c =100°C 12	
I _D	Continuous Drain Current	T _A =25°C 6.2	A
		T _A =70°C 5	
P _D	Maximum Power Dissipation	T _A =25°C 1.3	W
		T _A =70°C 0.8	
I _{AS} ⁽²⁾	Avalanche Current, Single pulse	L=0.1mH 18	A
E _{AS} ⁽²⁾	Avalanche Energy, Single pulse	L=0.1mH 16	mJ

Thermal Characteristics

Symbol	Parameter	Rating	Unit
R _{θJC}	Thermal Resistance-Junction to Case	Steady State 4.2	°C/W
R _{θJA} ⁽³⁾	Thermal Resistance-Junction to Ambient	Steady State 95	°C/W

Note ① : Max. current is limited by bonding wire

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz

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N-Channel Electrical Characteristics ($T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{DS}}=250\mu\text{A}$	45	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=36$ $V_{\text{GS}}=0\text{V}$	-	-	1	μA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{DS}}=250\mu\text{A}$	1.2	1.7	2	V
I_{GSS}	Gate Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	-	-	± 100	nA
$R_{\text{DS(ON)}}^{\circledast}$	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}$, $I_{\text{DS}}=20\text{A}$	-	15	18	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}$, $I_{\text{DS}}=15\text{A}$	-	16.8	22	
g_{fs}	Forward Transconductance	$V_{\text{DS}}=5\text{V}$, $I_{\text{DS}}=5\text{A}$	-	11	-	S
Dynamic Characteristics [®]						
R_{G}	Gate Resistance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=0\text{V}$, Freq.=1MHz	-	3.4	-	Ω
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=20\text{V}$, Freq.=1MHz	-	1048	-	pF
C_{oss}	Output Capacitance		-	83	-	
C_{rss}	Reverse Transfer Capacitance		-	64	-	
$t_{\text{d(ON)}}$	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=20\text{V}$, $I_{\text{D}}=1\text{A}$, $R_{\text{GEN}}=6\Omega$	-	5.7	-	nS
t_{r}	Turn-on Rise Time		-	21.2	-	
$t_{\text{d(OFF)}}$	Turn-off Delay Time		-	39.8	-	
t_{f}	Turn-off Fall Time		-	19.2	-	
Q_{g}	Total Gate Charge	$V_{\text{GS}}=4.5\text{V}$, $V_{\text{DS}}=25\text{V}$ $I_{\text{D}}=14\text{A}$	-	12.6	-	nC
Q_{g}	Total Gate Charge	$V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=25\text{V}$, $I_{\text{D}}=14\text{A}$	-	25.1	-	
Q_{gs}	Gate-Source Charge		-	1.5	-	
Q_{gd}	Gate-Drain Charge		-	6.8	-	
Source-Drain Characteristics						
$V_{\text{SD}}^{\circledast}$	Diode Forward Voltage	$I_{\text{SD}}=1\text{A}$, $V_{\text{GS}}=0\text{V}$	-	0.75	1.1	V
t_{rr}	Reverse Recovery Time	$I_{\text{F}}=1\text{A}$, $V_{\text{R}}=0\text{V}$	-	12.8	-	nS
Q_{rr}	Reverse Recovery Charge	$dI_{\text{F}}/dt=100\text{A}/\mu\text{s}$	-	6.2	-	nC

Note ④ : Pulse test (pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$).

Note ⑤ : Guaranteed by design, not subject to production testing.

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N-Channel Typical Characteristics

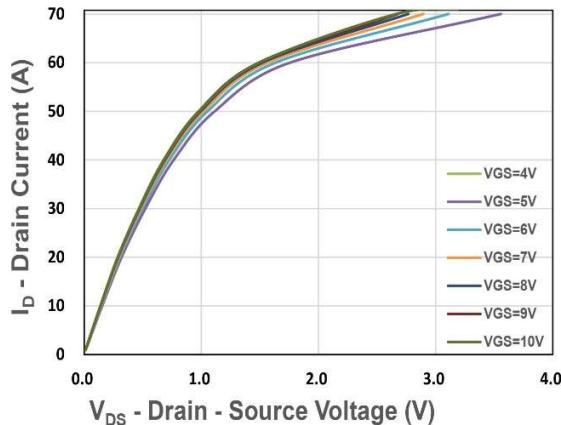


Figure 1. Output Characteristics

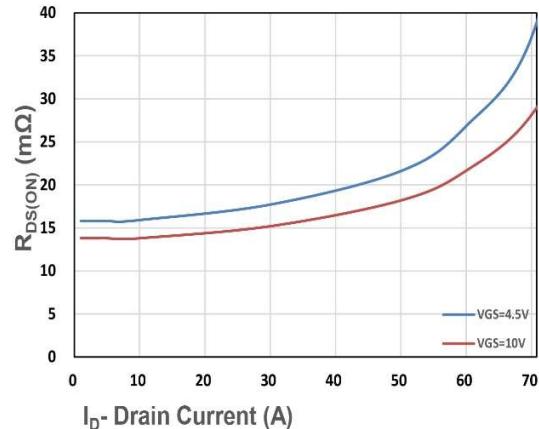


Figure 2. On-Resistance vs. ID

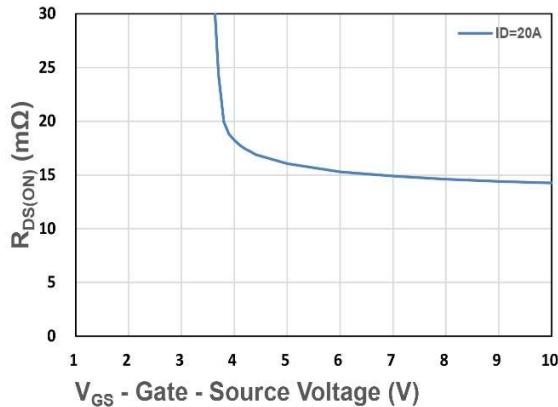


Figure 3. On-Resistance vs. VGS

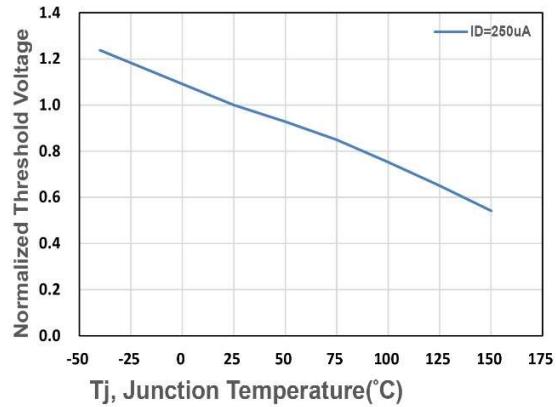


Figure 4. Gate Threshold Voltage

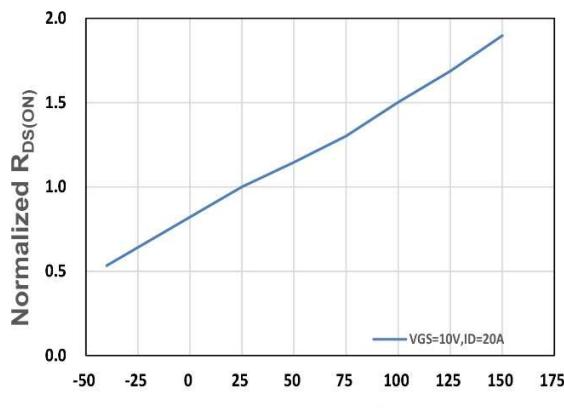


Figure 5. Drain-Source On Resistance

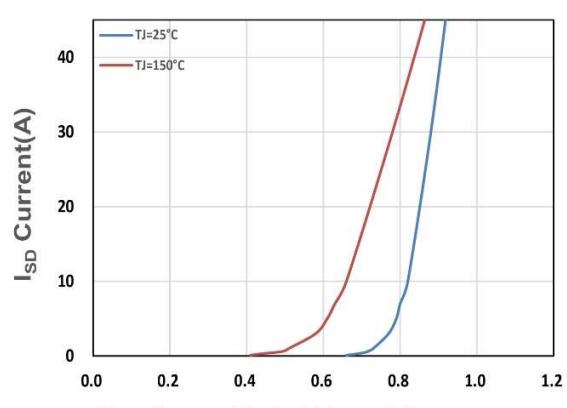


Figure 6. Source-Drain Diode Forward

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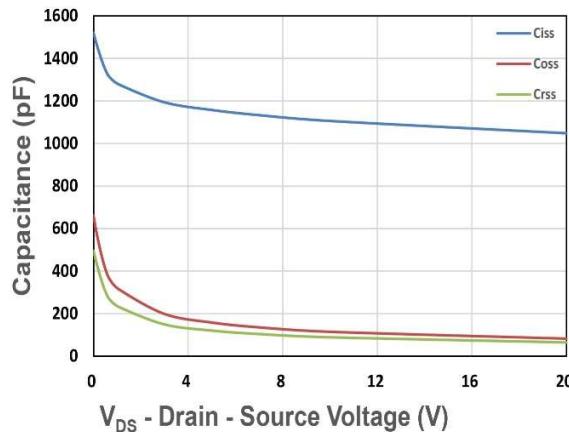


Figure 7. Capacitance

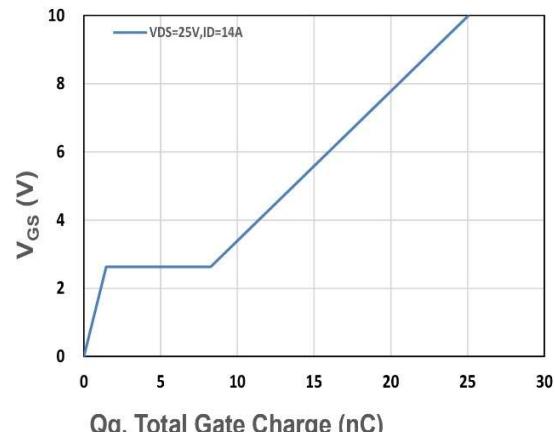


Figure 8. Gate Charge Characteristics

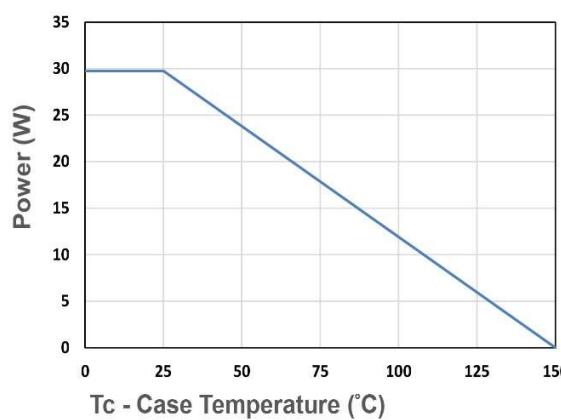


Figure 9. Power Dissipation

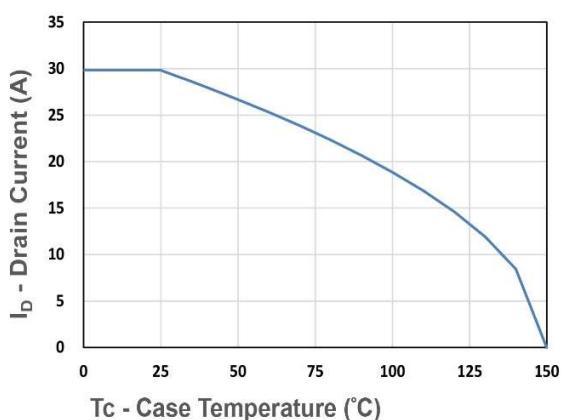


Figure 10. Drain Current

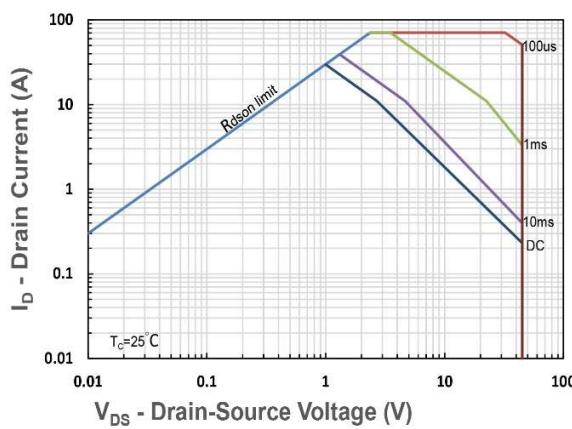


Figure 11. Safe Operating Area

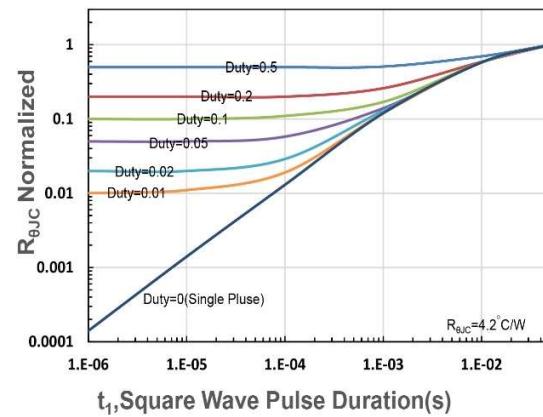


Figure 12. $R_{θJC}$ Transient Thermal Impedance